TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type (U-MOSⅢ)

SSM6K211FE

- High-Speed Switching Applications
- O Power Management Switch Applications
- 1.5-V drive

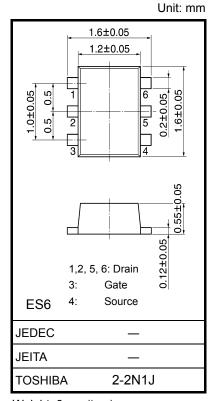
• Low ON-resistance: $R_{on} = 118 \text{ m}\Omega \text{ (max) (@V_{GS} = 1.5 V)}$

 $R_{on} = 82 \text{ m}\Omega \text{ (max) (@V}_{GS} = 1.8 \text{ V)}$ $R_{on} = 59 \text{ m}\Omega \text{ (max) (@V}_{GS} = 2.5 \text{ V)}$ $R_{on} = 47 \text{ m}\Omega \text{ (max) (@V}_{GS} = 4.5 \text{ V)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit		
Drain-source voltage	V_{DSS}	20	٧		
Gate-source voltage	V_{GSS}	± 10	٧		
Drain current	DC	ID	3.2	Α	
	Pulse	I _{DP}	6.4] ^	
Drain power dissipation	P _D (Note 1)	500	mW		
Channel temperature	T _{ch}	150	°C		
Storage temperature	T _{stg}	-55 to 150	°C		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



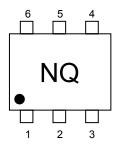
Weight: 3 mg (typ.)

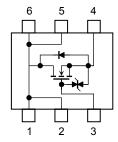
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board (25.4 mm \times 25.4 mm \times 1.6 mm, Cu Pad: 645 mm²)

Marking

Equivalent Circuit (top view)



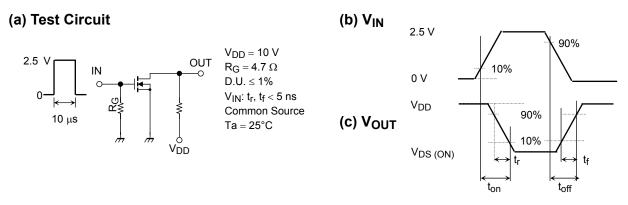


Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	ı	Min	Тур.	Max	Unit
Drain-source breakdown voltage	V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$ 20			_	_	V	
	V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -10 \text{ V}$	12	_	_	V		
Drain cutoff currer	nt	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V		_	_	1	μА
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	±1	μА
Gate threshold vo	Itage	V _{th}	$V_{DS} = 3 \text{ V}, I_D = 1 \text{ mA}$		0.35	_	1.0	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 2.0 \text{ A}$	(Note 2)	5.5	11.0	_	S
Drain-source ON-resistance		I _D = 2.0 A, V _{GS} = 4.5 V	(Note 2)	_	36	47	· mΩ	
	D (2)	I _D = 2.0 A, V _{GS} = 2.5 V	(Note 2)	_	44	59		
	R _{DS} (ON)	I _D = 1.0 A, V _{GS} = 1.8 V	(Note 2)	_	55	82		
		I _D = 0.5 A, V _{GS} = 1.5 V	(Note 2)	_	66	118		
Input capacitance		C _{iss}			_	510	_	
Output capacitance Reverse transfer capacitance		C _{oss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		_	98	_	pF
		C _{rss}		_	85			
		Q_g	V _{DS} = 10 V, I _D = 3.2 A V _{GS} = 4.5 V		_	10.8	_	nC
		Q_gs			_	8.6	_	
Gate-Drain Charge		Q_gd			_	2.2	_	
Switching time	Turn-on time	t _{on}	V _{DD} = 10 V, I _D = 1.0 A,		_	16	_	
	Turn-off time	t _{off}	$V_{GS} = 0$ to 2.5 V, $R_G = 4.7$ Ω	2	_	40	_	ns
Drain-source forward voltage		V _{DSF}	$I_D = -3.2 \text{ A}, V_{GS} = 0 \text{ V}$	(Note 2)	_	-0.84	-1.2	V

Note 2: Pulse test

Switching Time Test Circuit



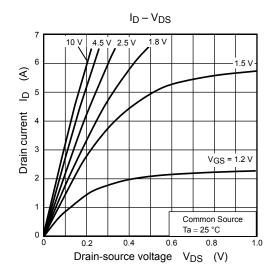
Usage Considerations

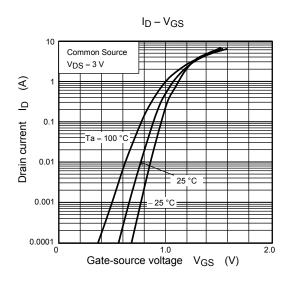
Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (1 mA for the SSM6K211FE). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$. Take this into consideration when using the device.

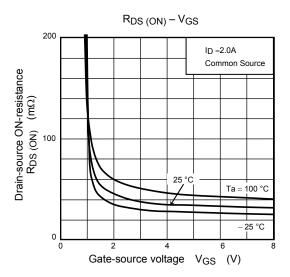
Handling Precaution

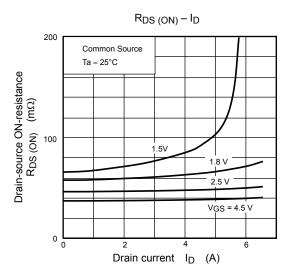
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

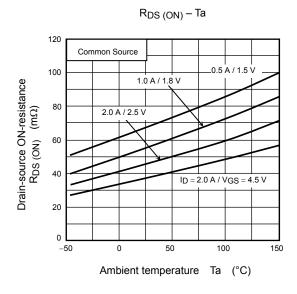
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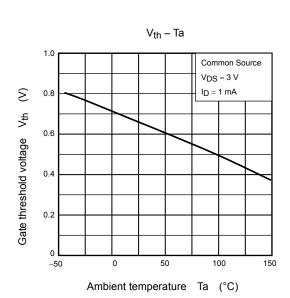


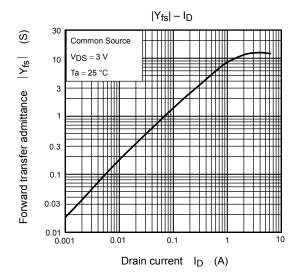


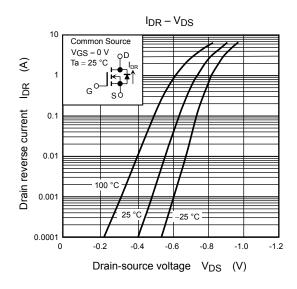


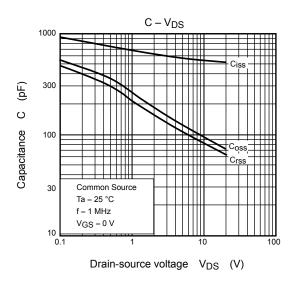


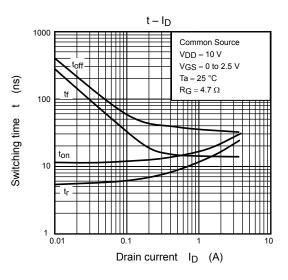


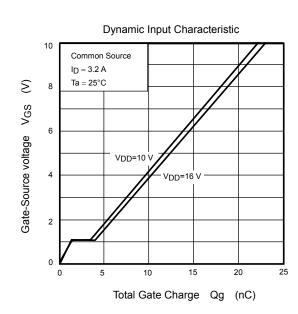




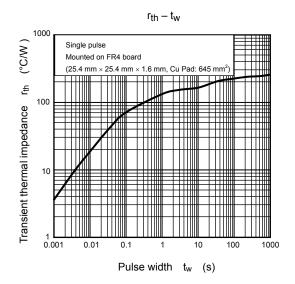


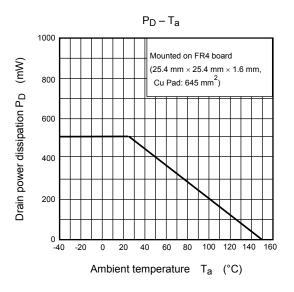






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